

SANGDEST

MICROELECTRONICS

S16LCC03-8 THRU S16LCC24-8

Green Products

TVS ARRAY SERIES

Technical Data Data Sheet N0290, Rev. -

FEATURES

- Protects 3.3, 5, 12, 15, 24 V Components
- \checkmark Bidirectional
- Low Capacitance 25 pF
- Provides Electrically Isolated Protection
- 300 W @ 8/20 us
- Protects 8 Lines
- ✓ SO-16 Packaging
- ✓ This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

DESCRIPTION

The S16LCCXX-8 series of TVS array have been designed to provide bidirectional protection for sensitive electronics from damage due to voltage transients caused by electrostatic discharge (ESD), electrical fast transients (EFT), lightning and other voltage-induced transient events. The device can be used to protect combinations of 8 bidirectional lines up to 24 volts.

SO-16

SCHEMATIC & PIN CONFIGURATION

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APPLICATION

- RS-422, RS-423, & RS-485 Interfaces
- WAN/LAN Equipment
- Wireless Communication Circuits
- Ethernet 10/100 Base T
- Low Voltage ASICs

MARKING DIAGRAM

Where XXXXX is YYWWL

MECHANICAL CHARACTERISTICS

Standard 481

SO-16 Surface Mount Package

Approximate Weight: 0.13 grams

PIN #1 Indicator: DOT on top of package

Packaging: Tubes or Tape & Reel per EIA

S16LCC03-8 = Part Name S = S YΥ = Year WW = Week L = Lot Number

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Cautions: Molding resin Epoxy resin UL:94V-0



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Ordering Information:

Device	Package	Shipping
S16LCC03-8 THRU S16LCC24-8	SO-16 (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit		
Р	Peak Pulse Power, 8/20 μs Waveshape	300	W		
TJ	Operating Temperature	-55 to +125	°C		
T _{STG}	Storage Temperature	-55 to +150	°C		
TL	Lead Soldering Temperature	260 (10 Sec.)	°C		



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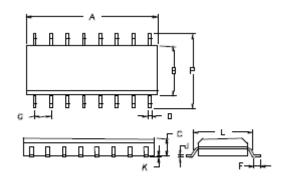
S16LCC03-8 THRU S16LCC24-8

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ELECTRICAL CHARACTERISTICS @ 25 °C						
Part Number	Stand-off	Breakdown	Clamping	Leakage	Capacitance	Temperature
	Voltage	Voltage	Voltage	Current	(f = 1MHz)	Coefficient
		V _{BR}	Vc	l _R	C	of V _{BR}
	Vwm	@1mA	@1A	@ V _{wm}	@ 0V	a(V _{BR})
	(v)	(V)	(V)	(µA)	(pF)	mv/°C
	Max	Min	Max	Max	Max	Max
S16LCC03-8	3.3	4	7	200	25	-5
S16LCC05-8	5.0	6	9.8	20	25	1
S16LCC12-8	12.0	13.3	19	1	25	8
S16LCC15-8	15.0	16.7	24	1	25	11
S16LCC24-8	24.0	26.7	43	1	25	28

PACKAGE OUTLINES & DEMENSIONS



	INC	HES	MILLIM	ETERS
DIM	MIN.	MAX	MIN.	MAX.
A	0.358	0.398	9.09	10.10
В	0.150	0.157	3.8	4.0
С	0.053	0.069	1.35	1.75
D	0.011	0.021	0.28	0.53
F	0.016	0.050	0.41	1.27
G	0.050 BSC		1.27 BSC	
J	0.006	0.010	0.15	0.25
K	0.004	0.008	0.10	0.20
L	0.189	0.206	4.80	5.23
P	0.228	0.244	5.79	6.19

TYPICAL CHARACTERISTICS

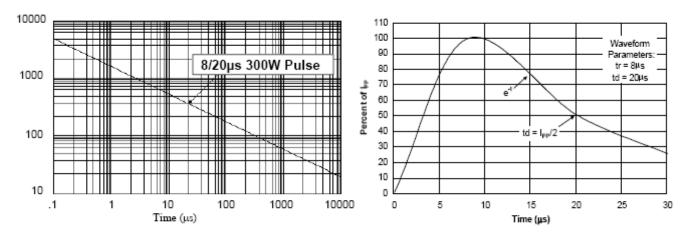


Figure 1. Peak Pulse Power Vs Pulse Time (µs)

Figure 2. Pulse Wave Form

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